

# **MR48V256B**

32,768-Word × 8-Bit FeRAM (Ferroelectric Random Access Memory)

### **GENERAL DESCRIPTION**

The MR48V256B is a nonvolatile 32,768-word x 8-bit ferroelectric random access memory (FeRAM) developed in the ferroelectric process and silicon-gate CMOS technology. Unlike SRAMs, this device, whose cells are nonvolatile, eliminates battery backup required to hold data. This device has no mechanisms of erasing and programming memory cells and blocks, such as those used for various EEPROMs. Therefore, the write cycle time can be equal to the read cycle time and the power consumption during a write can be reduced significantly. The MR48V256B can be used in various applications, because the device is guaranteed for the write/read tolerance of 10<sup>12</sup> cycles per bit and the rewrite count can be extended significantly.

### FEATURES

• 32,768-word × 8-bit configuration	
• A single 3.3 V $\pm$ 0.3 V power supply	
Read access time:	70 ns (Max.)
• Write enable time:	70 ns (Min.)
<ul> <li>Random read/write cycle time</li> </ul>	150 ns (Min.)
Read/write tolerance	10 <sup>12</sup> cycles/bit
Data retention	10 years
• Guaranteed operating temperature range	-40 to 85°C (Extended temperature version)
Package options:	
28-pin plastic TSOPI (TSOP(1)28-08134	-0.55-ZK)

### **PRODUCT FAMILY**

Family	Access Time		Read/Write	Daakaaa
	Relative to CE	Relative to OE	Cycle Time	Раскаде
MR48V256B	70ns	40ns	150ns	28pin TSOPI

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### PIN CONFIGURATION



28-pin plastic TSOPI

Note:

Signal names that end with # indicate that the pins are negative-true logic.

### **PIN DESCRIPTIONS**

Pin Name	Description
CE#	Chip enable (input, negative logic) Latches an address by low input, activates the FeRAM, and enables a read or write operation.
OE#	Output enable (input, negative logic) The FeRAM is in read mode when the FeRAM is active and this pin is low, and data is output after the specified time.
WE#	Write enable (input, negative logic) The FeRAM is in write mode when the FeRAM is active and this pin is low, and data is capture at the timing of WE#="H" or CE#="H", whichever is earlier.
A14 to A0	Address (input) The FeRAM captures an address at the timing when CE#="L" is established.
DQ7 to DQ0	3-state data bus (input/output) Outputs data in the read mode, and captures data in the write mode.
V <sub>CC</sub> , V <sub>SS</sub>	Power supply Apply the specified voltage to $V_{CC}$ . Connect $V_{SS}$ to ground.

### **TRUTH TABLE**

Operating Mode	CE#	WE#
Standby Mode	Н	Х
Address Latched	$\downarrow$	Х
Read Mode	L	Н
Write Mode	L	↓

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### **ELECTRICAL CHARACTERISTICS**

#### **Absolute Maximum Ratings**

Demension	Oursels al	Ra	ting	11	Nista	
Parameter	Symbol	Min.	Max.	Unit	note	
Pin Voltage (Input Signal)	V <sub>IN</sub>	-0.5	V <sub>CC</sub> + 0.5	V		
Pin Voltage (Input/Output Voltage)	V <sub>INQ</sub> , V <sub>OUTQ</sub>	-0.5	V <sub>CC</sub> + 0.5	V		
Power Supply Voltage	V <sub>CC</sub>	-0.5	4.6	V		
Storage Temperature (Extended Temperature Version)	Tstg	-55	125	°C		
Operating Temperature (Extended Temperature Version)	Topr	-40	85	°C		
Power Dissipation	P <sub>D</sub>		1,000	mW		
Allowable Input Current	I <sub>IN</sub>	$\pm 20$		mA	Ta=25°C	
Allowable Output Current	I <sub>OUT</sub>		$\pm 20$	mA	Ta=25°C	

Note:

The application of stress (voltage, current, or temperature) that exceeds the absolute maximum rating may damage the device. Therefore, do not allow actual characteristics to exceed any one parameter ratings

#### **Recommended Operating Conditions**

Parameter	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V <sub>cc</sub>	3.0	3.3	V	
Ground Voltage	V <sub>SS</sub>	0.0	0.0	V	
Input High Voltage	VIH	V <sub>CC</sub> x 0.8	V <sub>CC</sub> + 0.3	V	1
Input Low Voltage	V <sub>IL</sub>	-0.3	V <sub>CC</sub> x 0.15	V	2
Operating Temperature (Extended Temperature Version)	Та	-40	85	°C	

Notes:

1. Overshoots with the pulse width of 20 ns or less and the voltage of  $V_{CC}$  + 1.0 V or less are allowed.

2. Undershoots with the pulse width of 20 ns or less and the voltage of -1.0 V or more are allowed.

#### Capacitance

Parameter	Symbol	Min.	Max.	Unit	Note
Input Capacitance	C <sub>IN</sub>	—	6	pF	1
Input/Output Capacitance	C <sub>OUT</sub>		8	pF	1

Note:

Sampling value. Measurement conditions are  $V_{IN} = V_{OUT} = GND$ , f = 1MHz, and  $Ta = 25^{\circ}C$ 

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### **DC** Characteristics

(Under recommended operating conditions)						
Parameter	Symbol	Condition	Min.	Max.	Unit	Note
Output High Voltage	Vau	I <sub>ОН</sub> = –2 mA	$V_{CC} \times 0.85$	_	V	
Output high voltage	V OH					
	V	I <sub>OL</sub> = 2 mA		$V_{\text{CC}} \times 0.15$	V	
Oulput Low Voltage	VOL					
Input Leakage Current	ILI	—	-10	10	μA	
Output Leakage Current	I <sub>LO</sub>	_	-10	10	μA	
Power Supply Current		$V_{IN}$ = 0.2V or $V_{CC}$ –0.2V,				
(Standby)	I <sub>CCS</sub>	$CE\# = V_{CC}-0.2V$	—	400	μA	
(		I <sub>OUT</sub> = 0 mA				
Power Supply Current		Read Cycle, t <sub>RC</sub> = Min.				
Power Supply Current	I <sub>CCA</sub>	$V_{IN}$ = 0.2V or $V_{CC}$ –0.2V,		10	mA	1
		CE# = 0.2V, I <sub>OUT</sub> = 0 mA				

Note:

1. Average current. Address change must be one time or less during time  $t_{RC}$ .

#### **Read/Write Cycles and Data Retention**

		(Under recommen	nded operating	conditions)
Parameter	Min.	Max.	Unit	Note
Read/Write Cycle	10 <sup>12</sup>		Cycle	1
Data Retention	10		Year	

Notes:

1. This is applicable to the read cycle, write cycle, and CE-only cycle counts. This is the cycle count per bit (for one address).

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### AC Characteristics (Read Cycle)

· · · ·	(Under red	commended ope	erating co	nditions)	
Paramotor	Symbol	-70		Linit	Noto
Falanielei	Symbol	Min.	Max.	Onit	NOLE
Address Set-up Time	t <sub>AVEL</sub>	0	—	ns	
Address Hold Time (CE#)	t <sub>ELAX</sub>	10	—	ns	
CE# High Pulse Width	t <sub>EHEL</sub>	80	_	ns	
Output Hold Time (CE#)	t <sub>EHQX</sub>	5	—	ns	
Output High Impedance Time (CE#)	t <sub>EHQZ</sub>	—	25	ns	
CE# Active Time	t <sub>ELEH</sub>	70	2000	ns	
Read Cycle Time (CE# cycle Time)	t <sub>ELEL</sub>	150	—	ns	
CE# Access Time	t <sub>ELQV</sub>	—	70	ns	1
Output Low Impedance Time (CE#)	t <sub>EHQX</sub>	5	—	ns	
Output Hold Time (OE#)	t <sub>GHQX</sub>	5	—	ns	
Output High Impedance Time (OE#)	t <sub>GHQZ</sub>	—	25	ns	
OE# Access Time	t <sub>GLQV</sub>	—	40	ns	1
Output Low Impedance Time (OE#)	t <sub>GLQX</sub>	5	_	ns	

Notes:

The read data is output at the point where all of the maximum values of  $t_{ELQV}$  and  $t_{GLQV}$  are satisfied.

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### AC Characteristics (Write Cycle)

(Under recommended operating conditions) Note 1					
Daramatar	Symbol	-	Llnit	Noto	
	Symbol	Min.	Max.	Onit	Note
Address Set-up Time	t <sub>AVEL</sub>	0	—	ns	
Data Set-up Time (WE#)	t <sub>DVWH</sub>	20	—	ns	
Data Set-up Time (CE#)	t <sub>DVEH</sub>	40	—	ns	
Address Hold Time (CE#)	t <sub>ELAX</sub>	10	—	ns	
Data Hold Time (CE#)	t <sub>EHDX</sub>	0	—	ns	
CE# High Pulse Width	t <sub>EHEL</sub>	80	—	ns	
CE# Active Time	t <sub>ELEH</sub>	70	2000	ns	
Write Cycle Time (CE# Cycle Time)	t <sub>ELEL</sub>	150	—	ns	
Write Command Set-up Time (CE# to WE#)	t <sub>ELWH</sub>	70	—	ns	
Data Hold Time (WE#)	tWHDX	0	—	ns	
Write Command Pulse Width	t <sub>WLWH</sub>	40	—	ns	
WE# Set-up Time (CE#)	t <sub>ELWL</sub>	0		ns	1
WE# Hold Time (CE#)	tWHEH	0	—	ns	1

Notes:

"CE# controled WRITE"mode or "OE# controled WRITE" mode is decided by the rerationship between CE# and OE#.

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### **Timing Diagrams**

•Read cycle



•Write cycle



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•WE Control Write Cycle

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•CE-Only Cycle



Note: OE# = "H", WE# = "H", DQ = High-Z

•Power-On and Power-Off Characteristics

		(Under	r recomment	led operating	g conditions)
Parameter	Symbol	Min.	Max.	Unit	Note
Power-On CE# High Hold Time	t <sub>VHEL</sub>	50		μS	1, 2
Power-Off CE# High Hold Time	t <sub>EHVL</sub>	100		ns	1
Power-On Interval Time	t <sub>∨L∨H</sub>	1		μS	2

Notes:

1. To prevent an erroneous operation, be sure to maintain CE#="H", and set the FeRAM in an inactive state (standby mode) before and after power-on and power-off.

2. Powering on at the intermediate voltage level will cause an erroneous operation; thus, be sure to power up from 0 V.

3. Enter all signals at the same time as power-on or enter all signals after power-on.



### **REVISION HISTORY**

Document No.	Date	Page		
		Previous Edition	Current Edition	Description
PEDR48V256B-01	Jan. 24, 2013	-	-	Preliminary edition 1 from PJDR48V256A-06

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